RECTRON SEMICONDUCTOR
TECHNICAL SPECIFICATION

HFM301 THRU HFM308

SURFACE MOUNT GLASS PASSIVATED HIGH EFFICIENCY SILICON RECTIFIER

VOLTAGE RANGE 50 to 1000 Volts CURRENT 3.0 Ampere

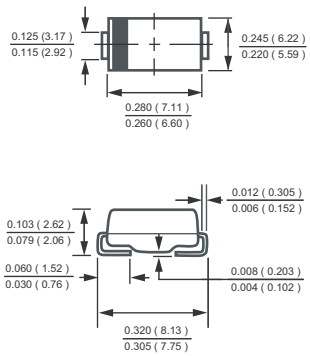
FEATURES

* Glass passivated device
* Ideal for surface mounted applications
* Low leakage current
* Metallurgically bonded construction
* Mounting position: Any
* Weight: 0.24 gram

MECHANICAL DATA

* Epoxy: Device has UL flammability classification 94V-O

DO-214AB



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.
resistive or inductive load.

MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS	SYMBOL	HFM301	HFM302	HFM303	HFM304	HFM305	HFM306	HFM307	HFM308	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	300	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	210	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	300	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T_L = 105 °C	I_O	3.0								Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	200					150			Amps
Current Squarad Time	I^2t	165.9					93.3			A^2/Sec
Typical Thermal Resistance (Note 1)	$R_{\theta JL}$	15								°C/W
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	60								°C/W
Typical Junction Capacitance (Note 2)	C_J	70					50			pF
Operating Temperature Range	T_J	-55 to + 150								°C
Storage Temperature Range	T_{STG}	-55 to + 150								°C

ELECTRICAL CHARACTERISTICS(@TA=25 °C unless otherwise noted)

CHARACTERISTICS		SYMBOL	HFM301	HFM302	HFM303	HFM304	HFM305	HFM306	HFM307	HFM308	UNITS
Maximum Instantaneous Forward Voltage at 3.0A DC		V_F	1.0			1.3		1.7			Volts
Maximum Full Load Reverse Current, Full cycle Average T_A =55°C		I_R	25								µA
Maximum Average Reverse Current	@T_A = 25°C		0.3								µA
at Rated DC Blocking Voltage	@T_A = 150°C		200								µA
Maximum Reverse Recovery Time (Note 4)		trr	50					75			nSec

NOTES : 1. Thermal Resistance : Mounted on PCB.
2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.
3. ROHS compliant
4. Test Conditions: I_F= 0.5A, I_R= -1.0A, I_{RR}= -0.25A.

2018-10
REV:D

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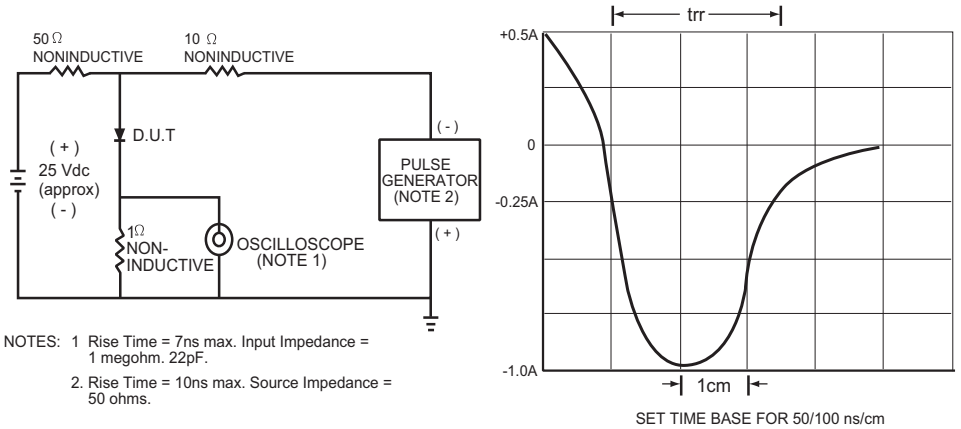
RATING AND CHARACTERISTICS CURVES (HFM301 THRU HFM308)



NOTES: 1 Rise Time = 7ns max. Input Impedance = 1 megohm. 22pF.

2. Rise Time = 10ns max. Source Impedance = 50 ohms.

FIG.1 TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

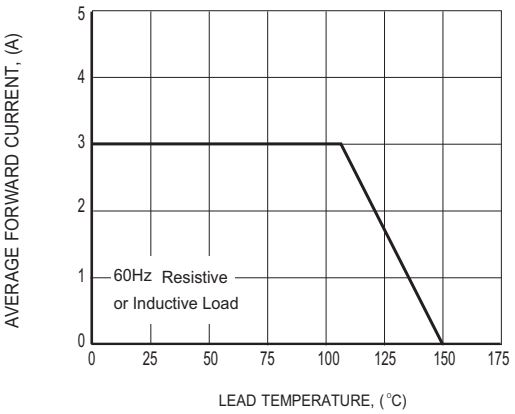


FIG.2 TYPICAL FORWARD CURRENT DERATING CURVE

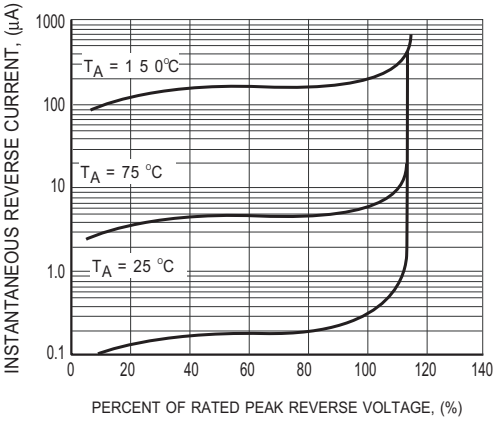


FIG.3 MAXIMUM REVERSE CHARACTERISTICS

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RATING AND CHARACTERISTICS CURVES (HFM301 THRU HFM308)

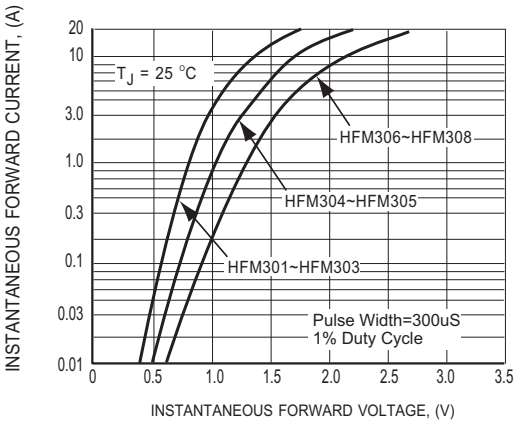

FIG.4 MAXIMUM INSTANTANEOUS FORWARD CHARACTERISTICS

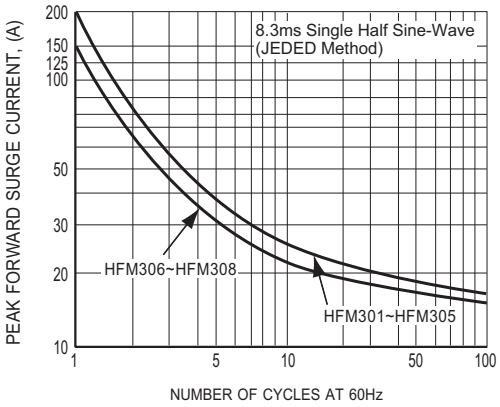

FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

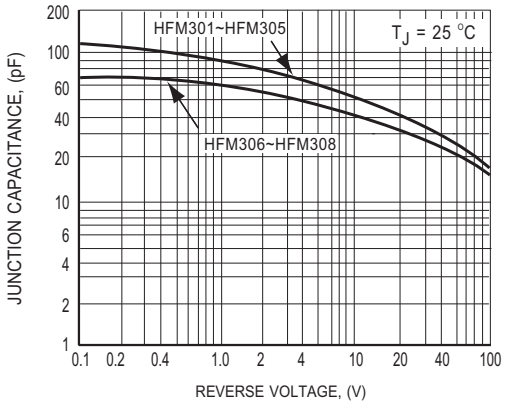

FIG.6 TYPICAL JUNCTION CAPACITANCE

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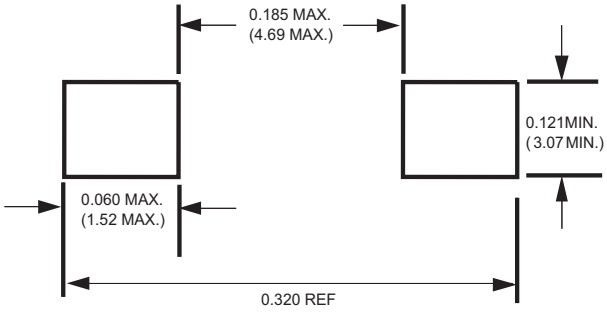
Mounting Pad Layout



Dimensions in inches and (millimeters)

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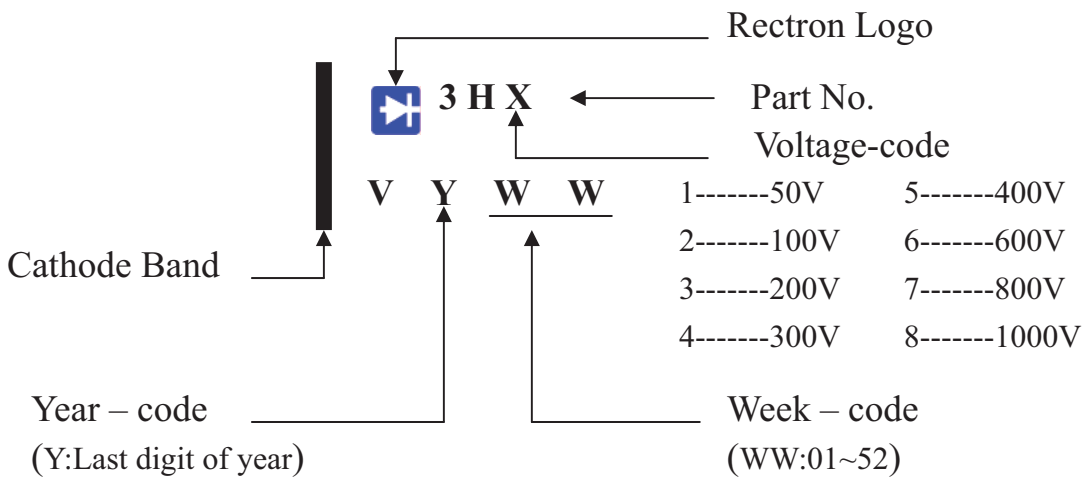
Marking Description



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PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMC	-W/-T	3,000	3,000	---	---	330	360*355*360	24,000	11.50

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